

# $I^2C^{\otimes}$ CMOS 8 × 8 Unbuffered Analog Switch Array with Dual/Single Supplies

### **Data Sheet**

### **FEATURES**

I<sup>2</sup>C-compatible interface 3.4 MHz high speed I<sup>2</sup>C option 32-lead LFCSP\_WQ (5 mm × 5 mm) **Double-buffered input logic** Simultaneous update of multiple switches Up to 300 MHz bandwidth Fully specified at dual ±5 V/single +12 V operation On resistance 35  $\Omega$  maximum Low quiescent current < 20 µA **Qualified for automotive applications** 

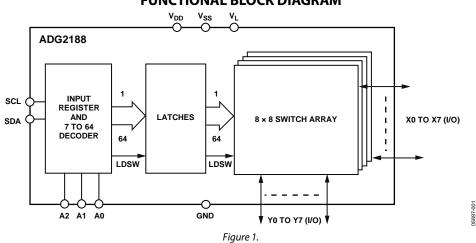
### **APPLICATIONS**

AV switching in TV Automotive infotainment **AV** receivers ссти **Ultrasound applications KVM** switching **Telecom applications Test equipment/instrumentation PBX systems** 

### **GENERAL DESCRIPTION**

The ADG2188 is an analog cross point switch with an array size of  $8 \times 8$ . The switch array is arranged so that there are eight columns by eight rows, for a total of 64 switch channels. The array is bidirectional, and the rows and columns can be configured as either inputs or outputs. Each of the 64 switches can be addressed and configured through the I<sup>2</sup>C-compatible interface. Standard, full speed, and high speed (3.4 MHz) I<sup>2</sup>C interfaces are supported. Any simultaneous switch combination is allowed. An additional feature of the ADG2188 is that switches can be updated simultaneously, using the LDSW command. In addition, a RESET option allows all of the switch channels to be reset/off. At power on, all switches are in the off condition. The device is packaged in a 32-lead,  $5 \text{ mm} \times 5 \text{ mm} \text{ LFCSP}_WQ$ .

**ADG2188** 



### FUNCTIONAL BLOCK DIAGRAM

#### **Document Feedback**

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Load Switch (LDSW)

### **REVISION HISTORY**

7/2017—Rev. A to Rev. B	
Changes to Figure 3	10
Changes to RESET/Power-On Reset Section	18
Updated Outline Dimensions	27
Changes to Ordering Guide	27

### 2/2015-Rev. 0 to Rev. A

Changed NC Pins to DNC Pins	10
Updated Outline Dimensions	27
Changes to Ordering Guide	27
Added Automotive Products Section	27

### 4/2006—Revision 0: Initial Version

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## **SPECIFICATIONS**

 $V_{DD}$  = 12 V ± 10%,  $V_{SS}$  = 0 V,  $V_L$  = 5 V, GND = 0 V, all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.<sup>1</sup>

### Table 1.

	<b>B</b> Version		Y	Y Version		
-		–40°C to		–40°C to		
Parameter	+25°C	+85°C	+25°C	+125°C	Unit	Test Conditions/Comments
ANALOG SWITCH						
Analog Signal Range		$V_{DD} - 2 V$		$V_{DD} - 2 V$	V max	
On Resistance, R <sub>on</sub>	30		30		Ω typ	$V_{DD} = 10.8 \text{ V}, V_{IN} = 0 \text{ V}, I_S = -10 \text{ mA}$
	35	40	35	42	Ωmax	
	32		32		Ω typ	$V_{DD} = 10.8 \text{ V}, V_{IN} = 1.4 \text{ V}, I_{S} = -10 \text{ mA}$
	37	42	37	47	Ωmax	
	45		45		Ω typ	$V_{DD} = 10.8 \text{ V}, V_{IN} = 5.4 \text{ V}, I_{S} = -10 \text{ mA}$
	50	57	50	62	Ωmax	
On Resistance Matching	4.5		4.5		Ωtyp	$V_{DD} = 10.8 V, V_{IN} = 0 V, I_s = -10 mA$
Between Channels, $\Delta R_{ON}$	8	9	8	10	Ωmax	
On Resistance Flatness, R <sub>FLAT(ON)</sub>	2.3		2.3		Ω typ	$V_{DD} = 10.8 \text{ V}, V_{IN} = 0 \text{ V}$ to $1.4 \text{ V}, I_S = -10 \text{ mA}$
	3.5	4	3.5	5	Ωmax	
	14.5		14.5		Ω typ	$V_{DD} = 10.8 V$ , $V_{IN} = 0 V$ to 5.4 V, $I_S = -10 mA$
	18	20	18	22	Ωmax	
LEAKAGE CURRENTS						$V_{DD} = 13.2 V$
Channel Off Leakage, IOFF	±0.03		±0.03		μA typ	$V_X = 7 V/1 V$ , $V_Y = 1 V/7 V$
Channel On Leakage, Ion	±0.03		±0.03		μA typ	$V_X = V_Y = 1 V \text{ or } 7 V$
DYNAMIC CHARACTERISTICS <sup>2</sup>						
Coff	11		11		pF typ	
Con	18.5		18.5		pF typ	
ton	170		170		ns typ	$R_L = 300 \Omega$ , $C_L = 35 pF$
	185	190	185	195	ns max	
toff	210		210		ns typ	$R_L = 300 \Omega$ , $C_L = 35 pF$
	250	255	250	260	ns max	
THD + N	0.04		0.04		% typ	$R_L = 10 \text{ k}\Omega$ , f = 20 Hz to 20 kHz, V <sub>s</sub> = 1 V p-p
PSRR			90		dB typ	f = 20 kHz; without decoupling; see Figure 24
–3 dB Bandwidth	210		210		MHz typ	Individual inputs to outputs
	16.5		16.5		MHz typ	8 inputs to 1 output
Off Isolation	-69		-69		dB typ	$R_L = 75 \Omega$ , $C_L = 5 pF$ , $f = 5 MHz$
Channel-to-Channel Crosstalk						$R_L = 75 \Omega$ , $C_L = 5 pF$ , $f = 5 MHz$
Adjacent Channels	-63		-63		dB typ	
Nonadjacent Channels	-76		-76		dB typ	
Differential Gain	0.4		0.4		% typ	$R_L = 75 \Omega$ , $C_L = 5 pF$ , $f = 5 MHz$
Differential Phase	0.6		0.6		° typ	$R_L = 75 \Omega, C_L = 5 pF, f = 5 MHz$
Charge Injection	-3.5		-3.5		pC typ	$V_{s} = 4 V, R_{s} = 0 \Omega, C_{L} = 1 nF$
LOGIC INPUTS (Ax, RESET) <sup>2</sup>						
Input High Voltage, V <sub>INH</sub>		2.0		2.0	V min	
Input Low Voltage, V <sub>INL</sub>		0.8		0.8	V max	
Input Leakage Current, $I_{IN}$	0.005		0.005		μA typ	
		±1		±1	µA max	
Input Capacitance, C <sub>IN</sub>	7		7		pF typ	

	B Version		Y Version			
		–40°C to		–40°C to		
Parameter	+25°C	+85°C	+25°C	+125°C	Unit	<b>Test Conditions/Comments</b>
LOGIC INPUTS (SCL, SDA) <sup>2</sup>						
Input High Voltage, V <sub>INH</sub>		0.7 VL		0.7 VL	V min	
		$V_L + 0.3$		$V_L + 0.3$	V max	
Input Low Voltage, VINL		-0.3		-0.3	V min	
		0.3 VL		0.3 VL	V max	
Input Leakage Current, I <sub>IN</sub>	0.005		0.005		μA typ	$V_{\text{IN}} = 0 \text{ V to } V_{\text{L}}$
		±1		±1	μA max	
Input Hysteresis		$0.05  V_{\text{L}}$		0.05 VL	V min	
Input Capacitance, C <sub>IN</sub>	7		7		pF typ	
LOGIC OUTPUT (SDA) <sup>2</sup>						
Output Low Voltage, V <sub>OL</sub>		0.4		0.4	V max	$I_{SINK} = 3 \text{ mA}$
		0.6		0.6	V max	$I_{SINK} = 6 \text{ mA}$
Floating State Leakage Current		±1		±1	μA max	
POWER REQUIREMENTS						
ldd	0.05		0.05		μA typ	Digital inputs = $0 V \text{ or } V_{L}$
		1		1	μA max	
lss	0.05		0.05		μA typ	Digital inputs = $0 V \text{ or } V_{L}$
		1		1	μA max	
l.						Digital inputs = $0 V \text{ or } V_{L}$
Interface Inactive	0.3		0.3		μA typ	
		2		2	μA max	
Interface Active: 400 kHz fscl	0.1		0.1		mA typ	
		0.2		0.2	mA max	
Interface Active: 3.4 MHz fscl	0.4		0.4		mA typ	-HS model only
		1.2		1.7	mA max	

 $^1$  Temperature range is as follows: B version: –40°C to +85°C; Y version: –40°C to +125°C.  $^2$  Guaranteed by design, not subject to production test.

## Data Sheet

 $V_{DD}$  = +5 V ± 10% ,  $V_{SS}$  = -5 V ± 10% ,  $V_L$  = 5 V, GND = 0 V, all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.<sup>1</sup>

#### Table 2.

±25°C		+25°C		Unit	Test Conditions/Comments
125 C	105 C	125 0	1125 C	onic	
			Vpp – 2 V	V max	
34		34	VDD 2V		$V_{DD} = +4.5 V$ , $V_{SS} = -4.5 V$ , $V_{IN} = V_{SS}$ , $I_S = -10 \text{ mA}$
	45		50		
	15		50		$V_{DD} = +4.5 V, V_{SS} = -4.5 V, V_{IN} = 0 V, I_{S} = -10 mA$
	65		70		
	05		, 0		$V_{DD} = +4.5 V, V_{SS} = -4.5 V, V_{IN} = +1.4 V, I_{S} = -10 \text{ mA}$
	85		95		
	05	-	22		$V_{DD} = +4.5 V, V_{SS} = -4.5 V, V_{IN} = V_{SS}, I_S = -10 mA$
	9		10		
	,		10		$V_{DD} = +4.5 V$ , $V_{SS} = -4.5 V$ , $V_{IN} = V_{SS}$ to 0 V, $I_{S} = -10 m$ .
	23		25		
20 34	23	20 34	23	Ωtyp	$V_{DD} = +4.5 \text{ V}, V_{SS} = -4.5 \text{ V}, V_{IN} = V_{SS} \text{ to } +1.4 \text{ V},$
42	45	42	48	O max	$I_s = -10 \text{ mA}$
14	15	12	10	32 110A	$V_{DD} = 5.5 V, V_{SS} = 5.5 V$
+0.03		+0.03		uA tvp	$V_x = +4.5 V/-2 V, V_y = -2 V/+4.5 V$
					$V_x = V_y = -2 V \text{ or } +4.5 V$
10.05		10.05		μπιγρ	
6		6		pF typ	
					$R_L = 300 \Omega, C_L = 35 pF$
	215		220	<i>·</i> · ·	
	215		220		$R_L = 300 \Omega, C_L = 35 pF$
	255		260	<i>,</i> ,	n = 300 12, Cl = 35 pi
	233		200		$R_L = 10 \text{ k}\Omega$ , f = 20 Hz to 20 kHz, Vs = 1 V p-p
0.04					f = 20 kHz; without decoupling; see Figure 24
300					Individual inputs to outputs
					8 inputs to 1 output
		-			$R_L = 75 \Omega$ , $C_L = 5 pF$ , $f = 5 MHz$
-00		-04		ubtyp	$R_L = 75 \Omega$ , $C_L = 5 pF$ , $f = 5 MHz$
67		67		dP two	$R_{L} = 73 \Omega_{2}, C_{L} = 3 \text{ pr}, 1 = 3 \text{ MHz}$
					$R_L = 75 \Omega$ , $C_L = 5 pF$ , $f = 5 MHz$
					$R_L = 75 \Omega$ , $C_L = 5 pF$ , $I = 5 MHZ$ $R_L = 75 \Omega$ , $C_L = 5 pF$ , $f = 5 MHZ$
					$R_L = 75 \Omega_2, C_L = 5 \text{ pr}, T = 5 \text{ MHZ}$ $V_S = 0 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{ nF}$
_J		د		he rìb	vs = 0 v, ns = 0 s2, CL = 1 m
	2.0		2.0	Vmin	
0.005	0.0	0.005	0.0		
0.005	+1	0.005	+1		
7	± 1	7	<u>- 1</u>		
,		, 		P1 (3P	
	0.7.1/		071/	Vmin	
	v <sub>L</sub> + 0.5 -0.3		v∟ + 0.5 –0.3	V min	
	-0.5	1	-0.5	V 111111	
			031/	Vmay	
0.005	$0.3V_L$	0.005	$0.3  V_L$	V max µA typ	$V_{IN} = 0 V \text{ to } V_L$
	+25°C 34 40 50 55 66 75 4.5 8 17 20	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	+25°C     +40°C to +85°C     +25°C       34     4     5       34     45     34       40     50     50       55     65     55       66     75     66       75     85     75       4.5     8     17       20     23     17       20     23     20       34     45     42       42     45     42       45     8     17       20     23     20       34     17     20       50     5     66       9.5     170     20       42     45     42       403     17     20       50     215     200       210     255     200       210     250     300       18     64     18       -66     15     15       1.5     1.5     1.5       1.5     <	-40°C to     -40°C to     -40°C to       34     34     34       34     40     50       34     40     50       50     50     70       55     65     55     70       66     66     75     85     75       4.5     75     95     70       66     75     85     75     95       4.5     75     95     10       17     17     20     23     20     25       34     17     20     23     34     10       170     203     20     25     20     20       170     70     170     20     220     20       170     215     200     220     20       210     215     250     260     20       250     255     250     260     20       18     -64     -14     -14     -14       -79 <t< td=""><td>-40°C to +25°C     -40°C to +25°C     -40°C to +125°C     Junit       34     VDD - 2V     Vmax     Atyp       34     40     50     Numax       40     40     50     Numax       50     50     70     Atyp       50     55     70     Atyp       55     65     55     95     Atyp       66     75     95     Atyp       75     85     75     95     Atyp       4.5     10     Atyp     Atyp       75     92     Atyp     Atyp       17     20     23     20     25     Atyp       203     21     42     48     Atyp       170     45     75     Presson     Atyp       170     200     215     Atyp     Atyp       170     215     200     220     Nsmax       170     215     200     220     Nsmax       170     215     250</td></t<>	-40°C to +25°C     -40°C to +25°C     -40°C to +125°C     Junit       34     VDD - 2V     Vmax     Atyp       34     40     50     Numax       40     40     50     Numax       50     50     70     Atyp       50     55     70     Atyp       55     65     55     95     Atyp       66     75     95     Atyp       75     85     75     95     Atyp       4.5     10     Atyp     Atyp       75     92     Atyp     Atyp       17     20     23     20     25     Atyp       203     21     42     48     Atyp       170     45     75     Presson     Atyp       170     200     215     Atyp     Atyp       170     215     200     220     Nsmax       170     215     200     220     Nsmax       170     215     250

	<b>B</b> Version		YV	ersion		
Parameter	+25°C	–40°C to +85°C	+25°C	–40°C to +125°C	Unit	Test Conditions/Comments
Input Hysteresis		0.05 VL		$0.05  V_L$	V min	
Input Capacitance, C <sub>IN</sub>	7		7		pF typ	
LOGIC OUTPUT (SDA) <sup>2</sup>						
Output Low Voltage, Vol		0.4		0.4	V max	I <sub>SINK</sub> = 3 mA
		0.6		0.6	V max	I <sub>SINK</sub> = 6 mA
Floating State Leakage Current		±1		±1	μA max	
POWER REQUIREMENTS						
lod	0.05		0.005		μA typ	Digital inputs = $0 V \text{ or } V_L$
		1		1	μA max	
lss	0.05		0.005		μA typ	Digital inputs = $0 V \text{ or } V_L$
		1		1	μA max	
lı.						Digital inputs = $0 V \text{ or } V_L$
Interface Inactive	0.3		0.3		μA typ	
		2		2	μA max	
Interface Active: 400 kHz fscl	0.1		0.1		mA typ	
		0.1		0.1	mA max	
Interface Active: 3.4 MHz f <sub>SCL</sub>	0.4		0.4		mA typ	-HS model only
		0.3		0.3	mA max	

 $^1$  Temperature range is as follows: B version: –40°C to +85°C; Y version: –40°C to +125°C.  $^2$  Guaranteed by design, not subject to production test.

### I<sup>2</sup>C TIMING SPECIFICATIONS

 $V_{DD} = 5 V$  to 12 V;  $V_{SS} = -5 V$  to 0 V;  $V_L = 5 V$ ; GND = 0 V;  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted (see Figure 2).

Table	3.
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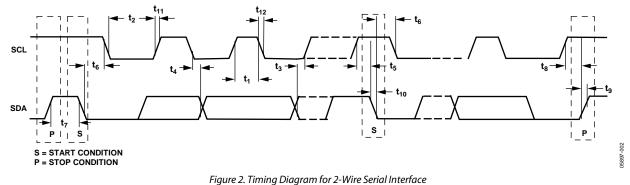
		ADG2188 Limit at T <sub>MIN</sub> , T <sub>MAX</sub>		ин, Тмах	
Parameter <sup>1</sup>	Test Conditions/Comments	Min	Max	Unit	Description
f <sub>scl</sub>	Standard mode		100	kHz	Serial clock frequency
	Fast mode		400	kHz	
	High speed mode <sup>2</sup>				
	$C_B = 100 \text{ pF} \text{ maximum}$		3.4	MHz	
	$C_B = 400 \text{ pF} \text{ maximum}$		1.7	MHz	
t1	Standard mode	4		μs	tніgн, SCL high time
	Fast mode	0.6		μs	
	High speed mode <sup>2</sup>				
	$C_B = 100 \text{ pF} \text{ maximum}$	60		ns	
	$C_B = 400 \text{ pF} \text{ maximum}$	120		ns	
<b>t</b> <sub>2</sub>	Standard mode	4.7		μs	tLOW, SCL low time
	Fast mode	1.3		μs	
	High speed mode <sup>2</sup>				
	$C_B = 100 \text{ pF} \text{ maximum}$	160		ns	
	$C_B = 400 \text{ pF} \text{ maximum}$	320		ns	
t <sub>3</sub>	Standard mode	250		ns	t <sub>su;DAT</sub> , data setup time
	Fast mode	100		ns	
	High speed mode <sup>2</sup>	10		ns	
t4 <sup>3</sup>	Standard mode	0	3.45	μs	t <sub>HD;DAT</sub> , data hold time
	Fast mode	0	0.9	μs	
	High speed mode <sup>2</sup>				
	$C_B = 100 \text{ pF} \text{ maximum}$	0	70	ns	
	$C_B = 400 \text{ pF} \text{ maximum}$	0	150	ns	
t₅	Standard mode	4.7		μs	t <sub>SU;STA</sub> , setup time for a repeated start condition
	Fast mode	0.6		μs	
	High speed mode <sup>2</sup>	160		ns	
t <sub>6</sub>	Standard mode	4		μs	t <sub>HD;STA</sub> , hold time for a (repeated) start condition
	Fast mode	0.6		μs	
	High speed mode <sup>2</sup>	160		ns	
t7	Standard mode	4.7		μs	$t_{\mbox{\scriptsize BUF}},$ bus free time between a stop and a start condition
	Fast mode	1.3		μs	
t8	Standard mode	4		μs	t <sub>su;sto</sub> , setup time for a stop condition
	Fast mode	0.6		μs	
	High speed mode <sup>2</sup>	160		ns	
t9	Standard mode		1000	ns	t <sub>RDA</sub> , rise time of SDA signal
	Fast mode	20 + 0.1 C <sub>B</sub>	300	ns	
	High speed mode <sup>2</sup>				
	$C_B = 100 \text{ pF} \text{ maximum}$	10	80	ns	
	$C_B = 400 \text{ pF} \text{ maximum}$	20	160	ns	
t <sub>10</sub>	Standard mode		300	ns	t <sub>FDA</sub> , fall time of SDA signal
	Fast mode	20 + 0.1 C <sub>B</sub>	300	ns	
	High speed mode <sup>2</sup>				
	$C_B = 100 \text{ pF} \text{ maximum}$	10	80	ns	
	$C_B = 400 \text{ pF} \text{ maximum}$	20	160	ns	

		ADG2188 L	imit at T <sub>№</sub>	IIN, TMAX	
Parameter <sup>1</sup> Test Conditions/Comments	Parameter <sup>1</sup>	Min	Мах	Unit	Description
<b>t</b> <sub>11</sub>	Standard mode		1000	ns	t <sub>RCL</sub> , rise time of SCL signal
	Fast mode	$20 + 0.1 C_B$	300	ns	
	High speed mode <sup>2</sup>				
	$C_B = 100 \text{ pF} \text{ maximum}$	10	40	ns	
	$C_B = 400 \text{ pF} \text{ maximum}$	20	80	ns	
t <sub>11A</sub>	Standard mode		1000	ns	t <sub>RCL1</sub> , rise time of SCL signal after a repeated start condition
	Fast mode	20 + 0.1 C <sub>B</sub>	300	ns	and after an acknowledge bit
	High speed mode <sup>2</sup>				
	$C_B = 100 \text{ pF} \text{ maximum}$	10	80	ns	
	$C_B = 400 \text{ pF} \text{ maximum}$	20	160	ns	
t <sub>12</sub>	Standard mode		300	ns	t <sub>FCL</sub> , fall time of SCL signal
	Fast mode	20 + 0.1 C <sub>B</sub>	300	ns	
	High speed mode <sup>2</sup>				
	$C_B = 100 \text{ pF} \text{ maximum}$	10	40	ns	
	$C_B = 400 \text{ pF} \text{ maximum}$	20	80	ns	
t <sub>SP</sub>	Fast mode	0	50	ns	Pulse width of suppressed spike
	High speed mode <sup>2</sup>	0	10	ns	

<sup>1</sup> Guaranteed by initial characterization. All values measured with input filtering enabled. C<sub>B</sub> refers to capacitive load on the bus line; t<sub>R</sub> and t<sub>F</sub> are measured between 0.3  $V_{\text{DD}}$  and 0.7  $V_{\text{DD}}.$ 

<sup>2</sup> High speed I<sup>2</sup>C is available only in -HS models
<sup>3</sup> A device must provide a data hold time for SDA to bridge the undefined region of the SCL falling edge.

### **TIMING DIAGRAM**



### **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25^{\circ}C$ , unless otherwise noted.

#### Table 4.

Parameter	Rating
V <sub>DD</sub> to V <sub>SS</sub>	15 V
V <sub>DD</sub> to GND	–0.3 V to +15 V
Vss to GND	+0.3 V to -7 V
V₋ to GND	–0.3 V to +7 V
Analog Inputs	$V_{\text{SS}}$ – 0.3 V to $V_{\text{DD}}$ + 0.3 V
Digital Inputs	-0.3 V to V <sub>L</sub> + 0.3 V or 30 mA, whichever occurs first
Continuous Current	
10 V on Input; Single Input Connected to Single Output	65 mA
1 V on Input; Single Input Connected to Single Output	90 mA
10 V on Input; Eight Inputs Connected to Eight Outputs	25 mA
Operating Temperature Range	
Industrial (B Version)	–40°C to +85°C
Automotive (Y Version)	–40°C to +125°C
Storage Temperature Range	–65°C to +150°C
Junction Temperature	150°C
32-Lead LFCSP_WQ	
$\theta_{JA}$ Thermal Impedance	108.2°C/W
Reflow Soldering (Pb Free)	
Peak Temperature	260°C (+0/–5)
Time at Peak Temperature	10 sec to 40 sec

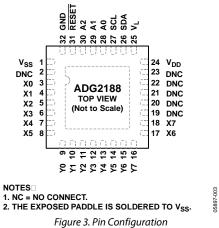
Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## **PIN CONFIGURATION AND FUNCTION DESCRIPTIONS**

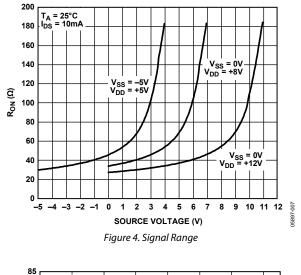


#### Table 5. Pin Function Descriptions<sup>1</sup>

Pin No.	Mnemonic	Description
1	V <sub>SS</sub>	Negative Power Supply in a Dual-Supply Application. For single-supply applications, this pin must be tied to GND.
2, 19 to 23	DNC	Do No Connect.
3 to 8,	X0 to X7	Can be inputs or outputs.
17, 18		
9 to 16	Y0 to Y7	Can be inputs or outputs.
24	V <sub>DD</sub>	Positive Power Supply Input.
25	VL	Logic Power Supply Input.
26	SDA	Digital I/O. Bidirectional open drain data line. External pull-up resistor required.
27	SCL	Digital Input, Serial Clock Line. Open drain input that is used in conjunction with SDA to clock data into the device. External pull-up resistor required.
28	A0	Logic Input. Address pin that sets the least significant bit of the 7-bit slave address.
29	A1	Logic Input. Address pin that sets the second least significant bit of the 7-bit slave address.
30	A2	Logic Input. Address pin that sets the third least significant bit of the 7-bit slave address.
31	RESET	Active Low Logic Input. When this pin is low, all switches are open, and appropriate registers are cleared to 0.
32	GND	Ground. Reference point for all circuitry on the ADG2188.
	EPAD	Exposed Paddle. The exposed paddle is soldered to Vss.

 $^{1}$  It is recommended that the exposed paddle be soldered to V<sub>ss</sub> to improve heat dissipation and crosstalk.

## **TYPICAL PERFORMANCE CHARACTERISTICS**



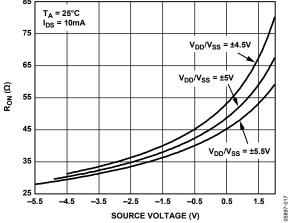
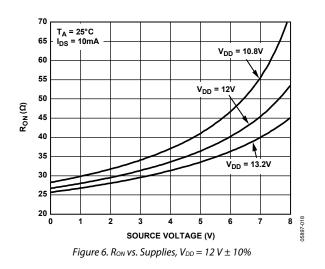


Figure 5. R<sub>ON</sub> vs. Source Voltage, Dual ±5 V Supplies



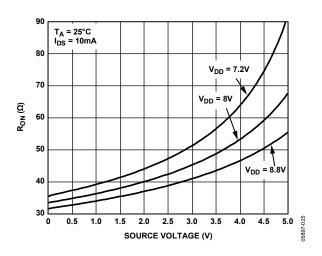


Figure 7.  $R_{ON}$  vs. Source Voltage,  $V_{DD} = 8 V \pm 10\%$ 

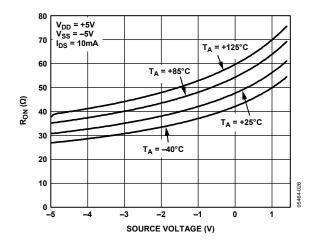
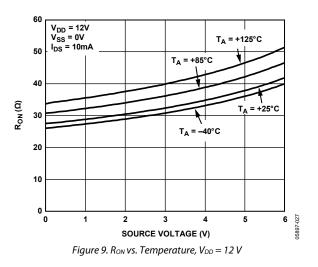


Figure 8.  $R_{ON}$  vs. Temperature, Dual  $\pm 5$  V Supplies



100

100

120 0110-111

05897-012

120

11 05897-030

9

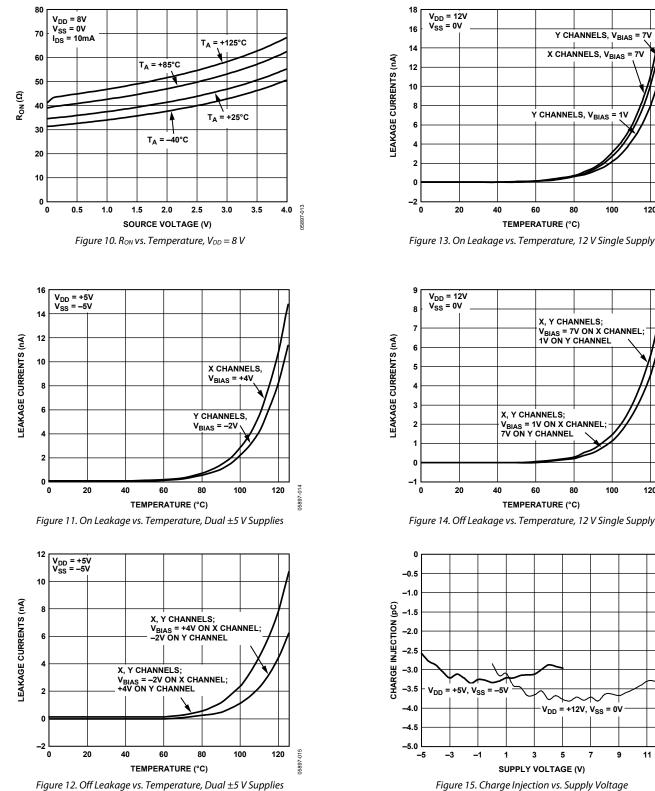
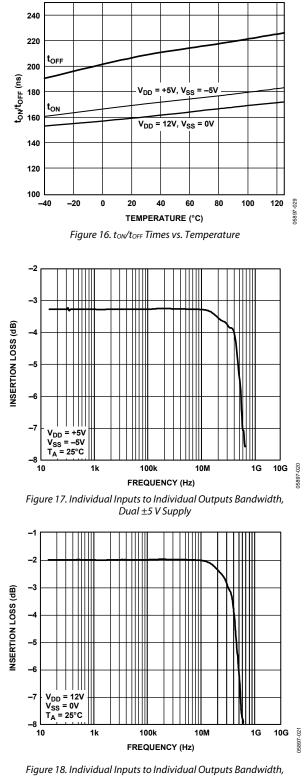


Figure 15. Charge Injection vs. Supply Voltage



12 V Single Supply

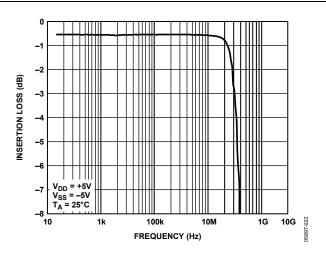


Figure 19. One Input to Eight Outputs Bandwidth,  $\pm 5$  V Dual Supply

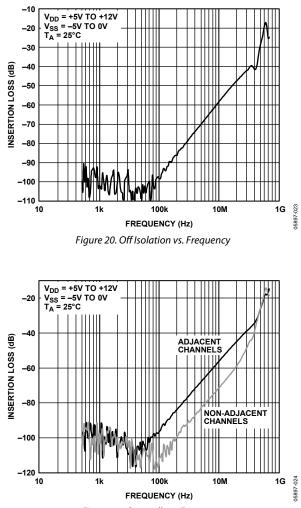


Figure 21. Crosstalk vs. Frequency

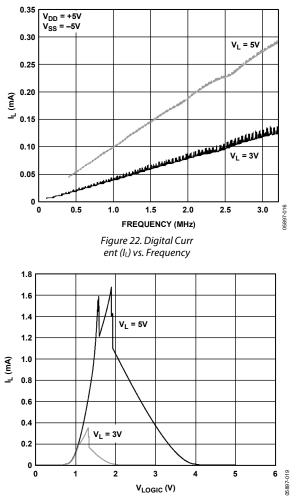
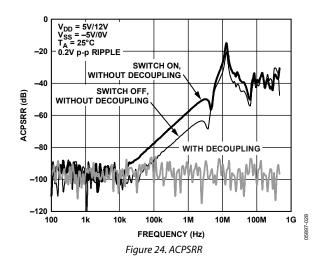
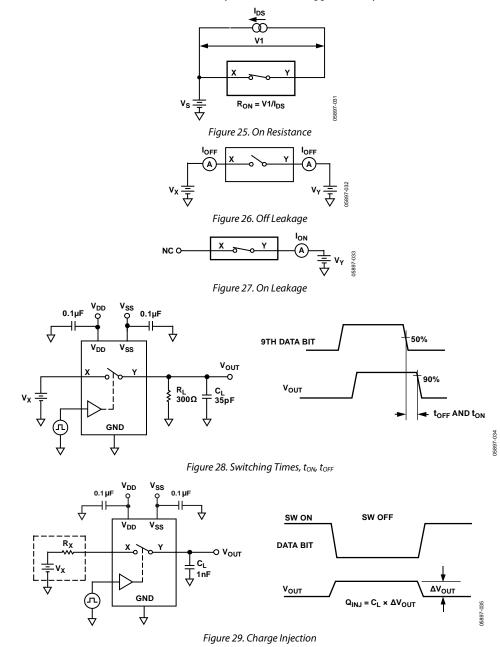


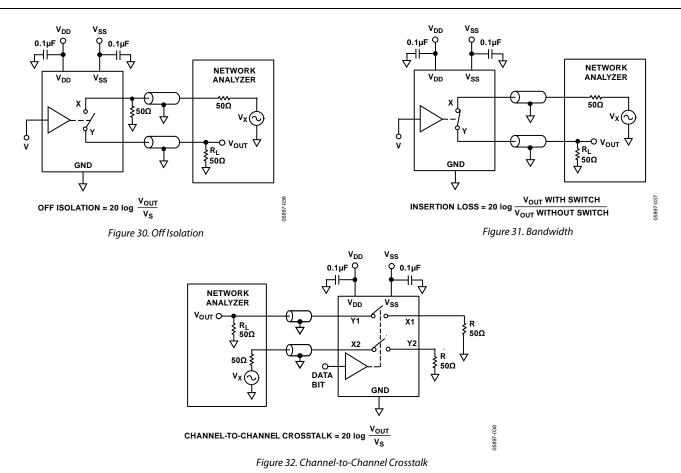
Figure 23. Digital Current ( $I_L$ ) vs.  $V_{LOGIC}$  for Varying Digital Supply Voltage



## **TEST CIRCUITS**

The test circuits show measurements on one channel for clarity, but the circuit applies to any of the switches in the matrix.





### TERMINOLOGY

**On Resistance (R**<sub>ON</sub>) The series on-channel resistance measured between the X input/output and the Y input/output.

On Resistance Match ( $\Delta R_{ON}$ ) The channel-to-channel matching of on resistance when channels are operated under identical conditions.

**On Resistance Flatness (R**<sub>FLAT(ON)</sub>**)** The variation of on resistance over the specified range produced by the specified analog input voltage change with a constant load current.

**Channel Off Leakage (I**OFF) The sum of leakage currents into or out of an off channel input.

**Channel On Leakage (I**<sub>ON</sub>) The current loss/gain through an on-channel resistance, creating a voltage offset across the device.

#### Input Leakage Current (IIN)

The current flowing into a digital input when a specified low level or high level voltage is applied to that input.

#### Input Off Capacitance (COFF)

The capacitance between an analog input and ground when the switch channel is off.

#### Input/Output On Capacitance (Con)

The capacitance between the inputs or outputs and ground when the switch channel is on.

### Digital Input Capacitance (C<sub>IN</sub>)

The capacitance between a digital input and ground.

#### Output On Switching Time (ton)

The time required for the switch channel to close. The time is measured from 50% of the logic input change to the time the output reaches 10% of the final value.

#### Output Off Switching Time (t<sub>OFF</sub>)

The time required for the switch to open. This time is measured from 50% of the logic input change to the time the output reaches 90% of the switch off condition.

#### Total Harmonic Distortion + Noise (THD + N)

The ratio of the harmonic amplitudes plus noise of a signal to the fundamental.

#### -3 dB Bandwidth

The frequency at which the output is attenuated by 3 dB.

#### **Off Isolation**

The measure of unwanted signal coupling through an off switch.

#### Crosstalk

The measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

#### **Differential Gain**

The measure of how much color saturation shift occurs when the luminance level changes. Both attenuation and amplification can occur; therefore, the largest amplitude change between any two levels is specified and is expressed as a percentage of the largest chrominance amplitude.

#### **Differential Phase**

The measure of how much hue shift occurs when the luminance level changes. It can be a negative or positive value and is expressed in degrees of subcarrier phase.

#### **Charge Injection**

The measure of the glitch impulse transferred from the digital input to the analog output during on/off switching.

**Input High Voltage (V**<sub>INH</sub>) The minimum input voltage for Logic 1.

**Input Low Voltage (V**<sub>INL</sub>) The maximum input voltage for Logic 0.

**Output Low Voltage (V**<sub>OL</sub>) The minimum input voltage for Logic 1.

**Input Low Voltage (V**<sub>INL</sub>) The maximum output voltage for Logic 0.

**I**<sub>DD</sub> Positive supply current.

Iss Negative supply current.

## THEORY OF OPERATION

The ADG2188 is an analog cross point switch with an array size of  $8 \times 8$ . The eight rows are referred to as the X input/output lines, and the eight columns are referred to as the Y input/output lines. The device is fully flexible in that it connects any X line or number of X lines with any Y line when turned on. Similarly, it connects any X line with any number of Y lines when turned on.

Control of the ADG2188 is carried out via an I<sup>2</sup>C interface. The device can be operated from single supplies of up to 13.2 V or from dual  $\pm 5$  V supplies. The ADG2188 has many attractive features, such as the ability to reset all the switches, the ability to update many switches at the same time, and the option of reading back the status of any switch. All of these features are described in more detail here in the Theory of Operation section.

### **RESET/POWER-ON RESET**

The ADG2188 offers the ability to reset all of the 64 switches to the off state. This is done through the RESET pin. When the RESET pin is low, all switches are open (off), and appropriate registers are cleared. Note that the ADG2188 also has a poweron reset block. This ensures that all switches are in the off condition at power-up of the device. In addition, all internal registers are filled with 0s and remain so until a valid write to the ADG2188 takes place.

The digital section of the ADG2188 goes through an initialization phase during the RESET power up. This initialization also occurs after a hardware or software reset. After reset, ensure that a minimum of 200 ns from the time of power-up or reset before any I<sup>2</sup>Ccommand is issued.

**Data Sheet** 

Ensure that RESET does not drop out during the 200 ns initialization phase because it can result in an incorrect operation of the ADG2188.

Ensure a minimum of 50 ns reset pulse width to achieve a complete reset.

### LOAD SWITCH (LDSW)

LDSW is an active high command that allows a number of switches to be simultaneously updated. This is useful in applications where it is important to have synchronous transmission of signals. There are two LDSW modes: the transparent mode and the latched mode.

### Transparent Mode

In this mode, the switch position changes after the new word is written into the input shift register. LDSW is set to 1.

### Latched Mode

In this mode, the switch positions are not updated at the same time that the input registers are written to. This is achieved by setting LDSW to 0 for each word (apart from the last word) written to the device. Then, setting LDSW to 1 for the last word allows all of the switches in that sequence to be simultaneously updated.

### READBACK

Readback of the switch array conditions is also offered when in standard mode and fast mode. Readback enables the user to check the status of the switches of the ADG2188. This is very useful when debugging a system.

### **SERIAL INTERFACE**

The ADG2188 is controlled via an I<sup>2</sup>C-compatible serial bus. The devices are connected to this bus as a slave device (no clock is generated by the switch).

### HIGH SPEED I<sup>2</sup>C INTERFACE

In addition to standard and full speed I<sup>2</sup>C, the ADG2188 also supports the high speed (3.4 MHz) I<sup>2</sup>C interface. Only the –HS models provide this added performance. See the Ordering Guide for details.

### SERIAL BUS ADDRESS

The ADG2188 has a 7-bit slave address. The four MSBs are hard coded to 1110, and the three LSBs are determined by the state of Pin A0, Pin A1, and Pin A2. By offering the facility to hardware configure Pin A0, Pin A1, and Pin A2, up to eight of these devices can be connected to a single serial bus.

The 2-wire serial bus protocol operates as follows:

1. The master initiates data transfer by establishing a start condition, defined as when a high-to-low transition on the SDA line occurs while SCL is high. This indicates that an address/data stream follows. All slave peripherals connected to the serial bus respond to the start condition and shift in the next eight bits, consisting of a 7-bit address (MSB first) plus an R/W bit that determines the direction of the data transfer, that is, whether data is written to or read from the slave device.

- 2. The peripheral whose address corresponds to the transmitted address responds by pulling the SDA line low during the ninth clock pulse, known as the acknowledge bit. At this stage, all other devices on the bus remain idle while the selected device waits for data to be written to or read from its serial register. If the R/W bit is 1 (high), the master reads from the slave device. If the R/W bit is 0 (low), the master writes to the slave device.
- 3. Data is transmitted over the serial bus in sequences of nine clock pulses: eight data bits followed by an acknowledge bit from the receiver of the data. Transitions on the SDA line must occur during the low period of the clock signal, SCL, and remain stable during the high period of SCL, because a low-to-high transition when the clock is high can be interpreted as a stop signal.
- 4. When all data bits have been read or written, a stop condition is established by the master. A stop condition is defined as a low-to-high transition on the SDA line while SCL is high. In write mode, the master pulls the SDA line high during the 10th clock pulse to establish a stop condition. In read mode, the master issues a no acknowledge for the ninth clock pulse (that is, the SDA line remains high). The master then brings the SDA line low before the 10th clock pulse and then high during the 10th clock pulse to establish a stop condition.

Refer to Figure 33 and Figure 34 for a graphical explanation of the serial data transfer protocol.

### WRITING TO THE ADG2188

### INPUT SHIFT REGISTER

The input shift register is 24 bits wide. A 3-byte write is necessary when writing to this register and is done under the control of the serial clock input, SCL. The contents of the three bytes of the input shift register are shown in Figure 33 and described in Table 6.

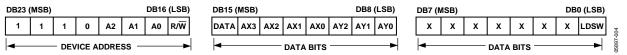


Figure 33. Data-Words

Table 6. Input Shift Register Bit Function Descriptions

Bit	Mnemonic	Description
DB23 to DB17	1110xxx	The MSBs of the ADG2188 are set to 1110. The LSBs of the address byte are set by the state of the three address pins, Pin A0, Pin A1, and Pin A2.
DB16	R/W	Controls whether the ADG2188 slave device is read from or written to.
		If $R/\overline{W} = 1$ , the ADG2188 is being read from.
		If $R/\overline{W} = 0$ , the ADG2188 is being written to.
DB15	Data	Controls whether the switch is to be open (off) or closed (on).
		If $Data = 0$ , the switch is open/off.
		If Data = 1, the switch is closed/on.
DB14 to DB11	AX3 to AX0	Controls I/Os X0 to X7. See Table 7 for the decode truth table.
DB10 to DB8	AY2 to AY0	Controls I/Os Y0 to Y7. See Table 7 for the decode truth table.
DB7 to DB1	Х	Don't care.
DB0	LDSW	This bit is useful when a number of switches need to be updated simultaneously.
		If LDSW = 1, the switch position changes after the new word is read in.
		If LDSW = 0, the input data is latched, but the switch position is not changed.

As shown in Table 6, Bit DB11 to Bit DB14 control the X input/output lines, while Bit DB8 to Bit DB10 control the Y input/output lines. Table 7 shows the truth table for these bits. Note that the full coding sequence is written out for Channel Y0, and Channel Y1 to Channel Y7 follow a similar pattern. Note also that the RESET pin must be high when writing to the device.

#### DB13 **DB11 DB15** DB14 **DB12 DB10** DB9 DB8 AY2 **Switch Configuration** DATA AX3 AX2 AX1 AX0 AY1 AY0 X0 to Y0 (on) X0 to Y0 (off) X1 to Y0 (on) X1 to Y0 (off) X2 to Y0 (on) X2 to Y0 (off) X3 to Y0 (on) X3 to Y0 (off) X4 to Y0 (on) X4 to Y0 (off) X5 to Y0 (on) X5 to Y0 (off) Х Reserved Х Reserved X6 to Y0 (on) X6 to Y0 (off) X7 to Y0 (on) X7 to Y0 (off) Х Reserved

#### Table 7. Address Decode Truth Table

## **Data Sheet**

DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	
DATA	AX3	AX2	AX1	AX0	AY2	AY1	AY0	Switch Configuration
Х	1	0	1	1	0	0	0	Reserved
Х	1	1	0	0	0	0	0	Reserved
Х	1	1	0	1	0	0	0	Reserved
Х	1	1	1	0	0	0	0	Reserved
Х	1	1	1	1	0	0	0	Reserved
1	0	0	0	0	0	0	1	X0 to Y1 (on)
0	0	0	0	0	0	0	1	X0 to Y1 (off)
1	1	0	0	1	0	0	1	X7 to Y1 (on)
1	0	0	0	0	0	1	0	X0 to Y2 (on)
0	0	0	0	0	0	1	0	X0 to Y2 (off)
1	1	0	0	1	0	1	0	X7 to Y2 (on)
1	0	0	0	0	0	1	1	X0 to Y3 (on)
0	0	0	0	0	0	1	1	X0 to Y3 (off)
1	1	0	0	1	0	1	1	X7 to Y3 (on)
1	0	0	0	0	1	0	0	X0 to Y4 (on)
0	0	0	0	0	1	0	0	X0 to Y4 (off)
0		-	-					
 1		 0	 0			 0	 0	X7 to Y4 (on)
1	0	0	0	0	1	0	1	X0 to Y5 (on)
0	0	0	0	0	1	0	1	X0 to Y5 (off)
0		-						X0 (0 15 (01)
 1		 0	 0			 0	 1	X7 to Y5 (on)
1	0	0	0	0	1	1	0	X0 to Y6 (on)
0	0	0	0	0	1	1	0	X0 to Y6 (off)
0		-	-					
 1								V7 to V6 (on)
1	1	0	0	1	1	1	0	X7 to Y6 (on) X0 to Y7 (on)
1	-	-	-	-				
0	0	0	0	0	1	1	1	X0 to Y7 (off)
1	1	0	0	1	1	1	1	X7 to Y7 (on)

### WRITE OPERATION

When writing to the ADG2188, the user must begin with an address byte and R/W bit, after which the switch acknowledges that it is prepared to receive data by pulling SDA low. This address byte is followed by the two 8-bit words. The write operations for the switch array are shown in Figure 34. Note that it is only the condition of the switch corresponding to the bits in the data bytes that changes state. All other switches retain their previous condition.

### **READ OPERATION**

Readback on the ADG2188 is designed to work as a tool for debug and can output the status of any of the 64 switches of the device. The readback function is a two-step sequence that works as follows:

- Select the relevant X line to be read back from. Note that there are eight switches connecting that X line to the eight Y lines. The next step involves writing to the ADG2188 to tell the device to reveal the status of those eight switches.
  - a. Enter the I<sup>2</sup>C address of the ADG2188, and set the  $R/\overline{W}$  to 0 to indicate a write to the device.

- b. Enter the readback address for the X line of interest, the addresses of which are shown in Table 8. Note that the ADG2188 is expecting a 2-byte write; therefore, be sure to also enter another byte of don't cares (see Figure 35).
- c. The ADG2188 then places the status of those eight switches in a register than can be read back.
- 2. The second step involves reading back from the register that holds the status of the eight switches associated with the X line of choice.
  - a. As before, enter the I<sup>2</sup>C address of the ADG2188. This time, set the  $R/\overline{W}$  to 1 to indicate a read back from the device.
  - d. As with a write to the device, the ADG2188 outputs a 2-byte sequence during readback. Therefore, the first eight bits of data out that are read back are all 0s. The next eight bits of data that come back are the status of the eight Y lines attached to that particular X line. If the bit is a 1, then the switch is closed (on); similarly, if the bit is a 0, the switch is open (off).

The entire read sequence is shown in Figure 35.

### 

			AX2 X AX1 X AX0 X AY2 X AY1	X AY0 X X 3	<u> </u>			
START COND BY MASTER	ADDRESS BYTE	ACK BY SWITCH	DATA BYTE	ACK BY SWITCH	DATA BYTE	ACK BY SWITCH	STOP COND BY MASTER	5897-005
MAGTER			Figure 34. Write Operati	on				8

X Line	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0
X0	0	0	1	1	0	1	0	0
X1	0	0	1	1	1	1	0	0
X2	0	1	1	1	0	1	0	0
Х3	0	1	1	1	1	1	0	0
X4	0	0	1	1	0	1	0	1
X5	0	0	1	1	1	1	0	1
X6	0	1	1	1	0	1	0	1
Х7	0	1	1	1	1	1	0	1

### Table 8. Readback Addresses for Each X Line

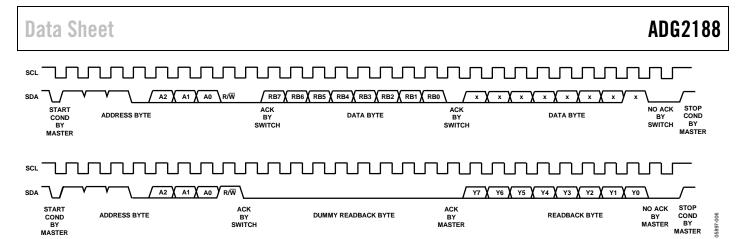


Figure 35. Read Operation

### **EVALUATION BOARD**

The ADG2188 evaluation board allows designers to evaluate the high performance  $8 \times 8$  switch array of the ADG2188 with a minimum of effort.

The evaluation kit includes a populated, tested ADG2188 printed circuit board. The evaluation board interfaces to the USB port of a PC, or it can be used as a standalone evaluation board. Software is available with the evaluation board that allows the user to easily program the ADG2188 through the USB port. Schematics of the evaluation board are shown in Figure 36 and Figure 37. The software runs on any PC that has Microsoft<sup>®</sup> Windows<sup>®</sup> 2000 or Windows XP installed.

### USING THE ADG2188 EVALUATION BOARD

The ADG2188 evaluation kit is a test system designed to simplify the evaluation of the ADG2188. Each input/output of the device comes with a socket specifically chosen for easy audio/video evaluation. An application note is also available with the evaluation board that gives full information on operating the evaluation board.

### **POWER SUPPLY**

The ADG2188 evaluation board can be operated with both single and dual supplies.  $V_{DD}$  and  $V_{SS}$  are supplied externally by the user. The  $V_L$  supply can be applied externally, or the USB port can power the digital circuitry.

## Data Sheet

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### SCHEMATICS

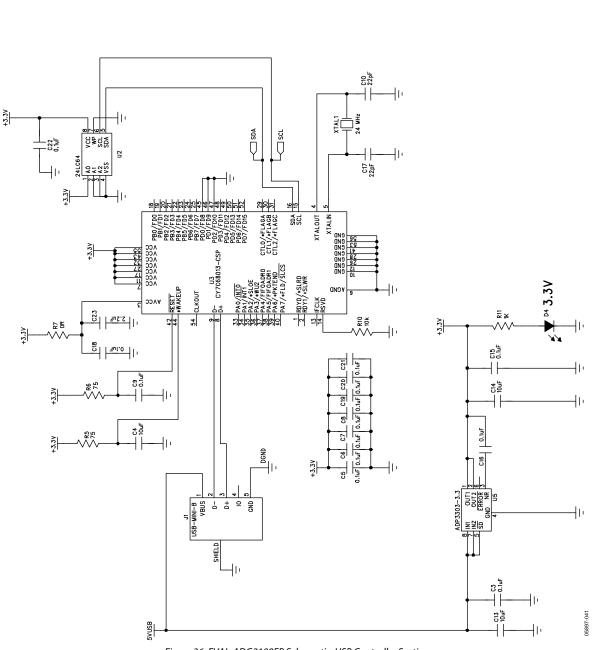


Figure 36. EVAL-ADG2188EB Schematic, USB Controller Section

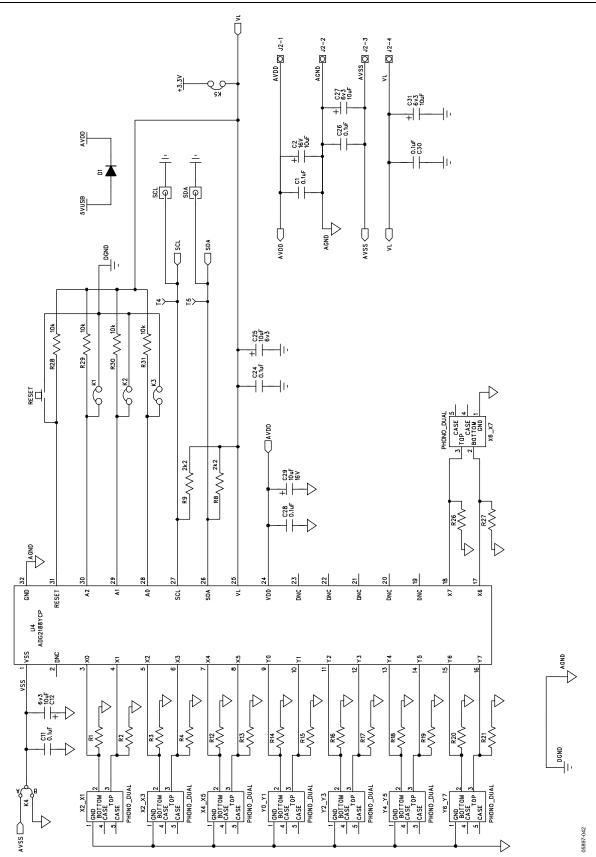
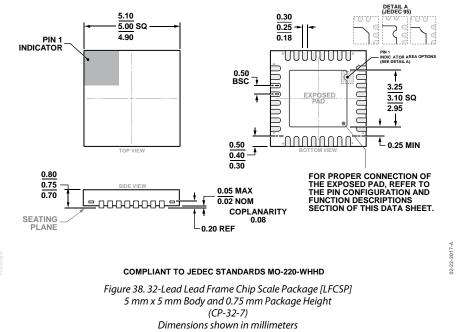


Figure 37. EVAL-ADG2188EB Schematic, Chip Section

## **OUTLINE DIMENSIONS**



### **ORDERING GUIDE**

Model <sup>1, 2</sup>	Temperature Range	l <sup>2</sup> C Speed	Package Description	Package Option
ADG2188BCPZ-REEL7	-40°C to +85°C	100 kHz, 400 kHz	32-Lead Lead Frame Chip Scale Package [LFCSP]	CP-32-7
ADG2188YCPZ-REEL7	-40°C to +125°C	100 kHz, 400 kHz	32-Lead Lead Frame Chip Scale Package [LFCSP]	CP-32-7
ADW54012Z-0REEL7	-40°C to +85°C	100 kHz, 400 kHz	32-Lead Lead Frame Chip Scale Package [LFCSP]	CP-32-7
EVAL-ADG2188EBZ			8 x 8 Evaluation Board	

 $^{1}$  Z = RoHS Compliant Part.

<sup>2</sup> W = Qualified for Automotive Applications.

### **AUTOMOTIVE PRODUCTS**

The ADW54012 model is available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that this automotive model may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

## **Data Sheet**

## NOTES

I<sup>2</sup>C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

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